

# 1N3004W Silicon Epitaxial Planar Diode

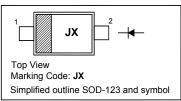
High Voltage Switching Diode

### **Features**

- Fast switching speed
- High Conductance
- High Reverse Breakdown Voltage

#### PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



Absolute Maximum Ratings (T<sub>a</sub> = 25 °C)

Parameter		Symbol	Value	Unit
Repetitive Peak Reverse Voltage		$V_{RRM}$	350	V
Working Peak Reverse Voltage	$V_{RWM}$	300	V	
Reverse Voltage		V <sub>R</sub>	300	V
Continuous Forward Current		I <sub>F</sub>	225	mA
Peak Repetitive Forward Current		I <sub>FRM</sub>	625	mA
Non-Repetitive Peak Forward Surge Current	at t = 1 μs at t = 1 s	I <sub>FSM</sub>	4 1	А
Power Dissipation		$P_d$	350	mW
Operating and Storage Temperature Range		$T_j$ , $T_{stg}$	- 65 to + 150	°C

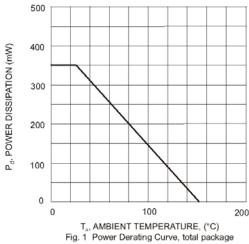
#### Characteristics at T<sub>a</sub> = 25 °C

Parameter	Symbol	Min.	Max.	Unit
Forward Voltage at $I_F$ = 20 mA at $I_F$ = 100 mA at $I_F$ = 200 mA	V <sub>F</sub>		0.87 1 1.25	<b>V</b>
Reverse Current at $V_R$ = 240 V at $V_R$ = 240 V, $T_j$ = 150 °C	I <sub>R</sub>		100 100	nΑ μΑ
Reverse Breakdown Voltage at I <sub>R</sub> = 100 μA	$V_{(BR)R}$	300	-	V
Total Capacitance at $V_R = 0$ , $f = 1$ MHz	C <sub>T</sub>	-	5	pF
Reverse Recovery Time at $I_F = I_R = 30$ mA, $I_{rr} = 0.1$ $I_R$ , $R_L = 100$ $\Omega$	t <sub>rr</sub>	-	50	ns

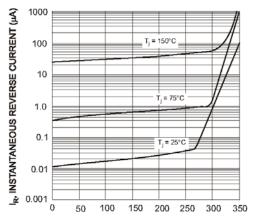
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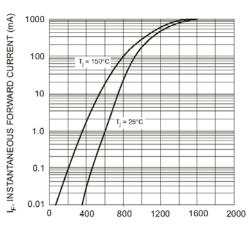
## **Typical Characteristics**



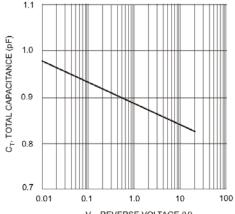




V<sub>R</sub>, INSTANTANEOUS REVERSE VOLTAGE (V) Fig. 3 Typical Reverse Characteristics, per element



V<sub>E</sub>, INSTANTANEOUS FORWARD VOLTAGE (mV) Fig. 2 Typical Forward Characteristics, per element



V<sub>R</sub>, REVERSE VOLTAGE (V) Fig. 4 Typical Total Capacitance vs. Reverse Voltage, per element

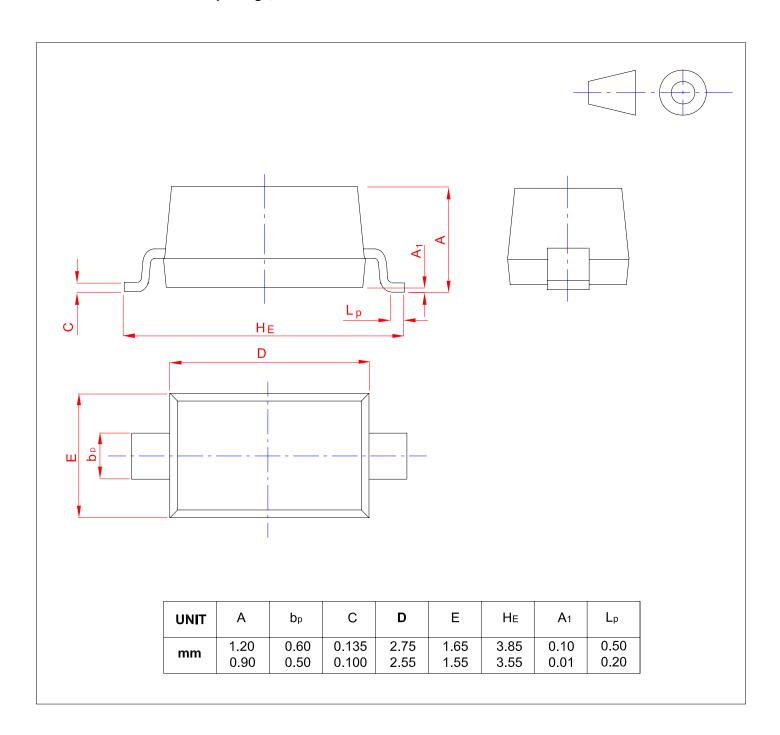
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### **PACKAGE OUTLINE**

Plastic surface mounted package; 2 leads

**SOD-123** 



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